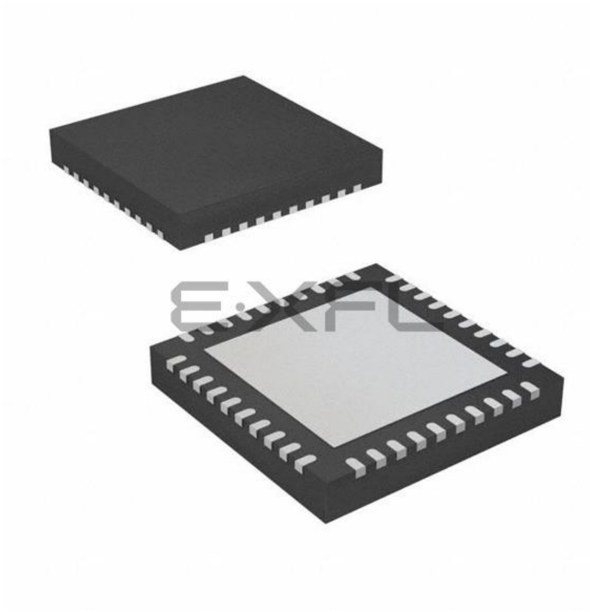
Microchip Technology - PIC16LF15376-E/MV Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	224 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf15376-e-mv

1.1 Register and Bit Naming Conventions

1.1.1 REGISTER NAMES

When there are multiple instances of the same peripheral in a device, the peripheral control registers will be depicted as the concatenation of a peripheral identifier, peripheral instance, and control identifier. The control registers section will show just one instance of all the register names with an ‘x’ in the place of the peripheral instance number. This naming convention may also be applied to peripherals when there is only one instance of that peripheral in the device to maintain compatibility with other devices in the family that contain more than one.

1.1.2 BIT NAMES

There are two variants for bit names:

- Short name: Bit function abbreviation
- Long name: Peripheral abbreviation + short name

1.1.2.1 Short Bit Names

Short bit names are an abbreviation for the bit function. For example, some peripherals are enabled with the EN bit. The bit names shown in the registers are the short name variant.

Short bit names are useful when accessing bits in C programs. The general format for accessing bits by the short name is *RegisterName*bits.*ShortName*. For example, the enable bit, EN, in the COG1CON0 register can be set in C programs with the instruction `COG1CON0bits.EN = 1`.

Short names are generally not useful in assembly programs because the same name may be used by different peripherals in different bit positions. When this occurs, during the include file generation, all instances of that short bit name are appended with an underscore plus the name of the register in which the bit resides to avoid naming contentions.

1.1.2.2 Long Bit Names

Long bit names are constructed by adding a peripheral abbreviation prefix to the short name. The prefix is unique to the peripheral thereby making every long bit name unique. The long bit name for the COG1 enable bit is the COG1 prefix, G1, appended with the enable bit short name, EN, resulting in the unique bit name G1EN.

Long bit names are useful in both C and assembly programs. For example, in C the COG1CON0 enable bit can be set with the `G1EN = 1` instruction. In assembly, this bit can be set with the `BSF  COG1CON0,G1EN` instruction.

1.1.2.3 Bit Fields

Bit fields are two or more adjacent bits in the same register. Bit fields adhere only to the short bit naming convention. For example, the three Least Significant bits of the COG1CON0 register contain the mode control bits. The short name for this field is MD. There is no long bit name variant. Bit field access is only possible in C programs. The following example demonstrates a C program instruction for setting the COG1 to the Push-Pull mode:

```
COG1CON0bits.MD = 0x5;
```

Individual bits in a bit field can also be accessed with long and short bit names. Each bit is the field name appended with the number of the bit position within the field. For example, the Most Significant mode bit has the short bit name MD2 and the long bit name is G1MD2. The following two examples demonstrate assembly program sequences for setting the COG1 to Push-Pull mode:

Example 1:

```
MOVLW  ~(1<<G1MD1)
ANDWF  COG1CON0,F
MOVLW  1<<G1MD2 | 1<<G1MD0
IORWF  COG1CON0,F
```

Example 2:

```
BSF    COG1CON0,G1MD2
BCF    COG1CON0,G1MD1
BSF    COG1CON0,G1MD0
```

1.1.3 REGISTER AND BIT NAMING EXCEPTIONS

1.1.3.1 Status, Interrupt, and Mirror Bits

Status, interrupt enables, interrupt flags, and mirror bits are contained in registers that span more than one peripheral. In these cases, the bit name shown is unique so there is no prefix or short name variant.

1.1.3.2 Legacy Peripherals

There are some peripherals that do not strictly adhere to these naming conventions. Peripherals that have existed for many years and are present in almost every device are the exceptions. These exceptions were necessary to limit the adverse impact of the new conventions on legacy code. Peripherals that do adhere to the new convention will include a table in the registers section indicating the long name prefix for each peripheral instance. Peripherals that fall into the exception category will not have this table. These peripherals include, but are not limited to, the following:

- EUSART
- MSSP

TABLE 1-2: PIC16(L)F15356 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB3/ANB3/C1IN2-/C2IN2-/IOCB3	RB3	TTL/ST	CMOS/OD	General purpose I/O.
	ANB3	AN	—	ADC Channel B3 input.
	C1IN2-	AN	—	Comparator 1 negative input.
	C2IN2-	AN	—	Comparator 2 negative input.
	IOCB3	TTL/ST	—	Interrupt-on-change input.
RB4/ANB4/ADACT(1)/IOCB4	RB4	TTL/ST	CMOS/OD	General purpose I/O.
	ANB4	AN	—	ADC Channel B4 input.
	ADACT(1)	TTL/ST	—	ADC Auto-Conversion Trigger input.
	IOCB4	TTL/ST	—	Interrupt-on-change input.
RB5/ANB5/T1G(1)/IOCB5	RB5	TTL/ST	CMOS/OD	General purpose I/O.
	ANB5	AN	—	ADC Channel B5 input.
	T1G(1)	ST	—	Timer1 Gate input.
	IOCB5	TTL/ST	—	Interrupt-on-change input.
RB6/ANB6/CLCIN2(1)/IOCB6/TX2/CK2(3)/ICSPCLK	RB6	TTL/ST	CMOS/OD	General purpose I/O.
	ANB6	AN	—	ADC Channel B6 input.
	CLCIN2(1)	TTL/ST	—	Configurable Logic Cell source input.
	IOCB6	TTL/ST	—	Interrupt-on-change input.
	TX2	—	CMOS	EUSART2 asynchronous.
	CK2(3)	TTL/ST	CMOS/OD	EUSART2 synchronous mode clock input/output.
	ICSPCLK	ST	—	In-Circuit Serial Programming™ and debugging clock input.
RB7/ANB7/RX2/DT2/CLCIN3(1)/IOCB7/DAC1OUT2/ICSPDAT	RB7	TTL/ST	CMOS/OD	General purpose I/O.
	ANB7	AN	—	ADC Channel B7 input.
	CLCIN3(1)	TTL/ST	—	Configurable Logic Cell source input.
	IOCB7	TTL/ST	—	Interrupt-on-change input.
	RX2(1)	TTL/ST	—	EUSART2 Asynchronous mode receiver data input.
	DT2(3)	TTL/ST	CMOS/OD	EUSART2 Synchronous mode data input/output.
	DAC1OUT2	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	ST	CMOS	In-Circuit Serial Programming™ and debugging data input/output.
RC0/ANC0/T1CKI(1)/IOCC0/SOSCO	RC0	TTL/ST	CMOS/OD	General purpose I/O.
	ANC0	AN	—	ADC Channel C0 input.
	T1CKI(1)	TTL/ST	—	Timer1 external digital clock input.
	IOCC0	TTL/ST	—	Interrupt-on-change input.
	SOSCO	—	AN	32.768 kHz secondary oscillator crystal driver output.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^{2}C = Schmitt Trigger input with I^{2}C
HV = High Voltage XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 15-4 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 15-3.

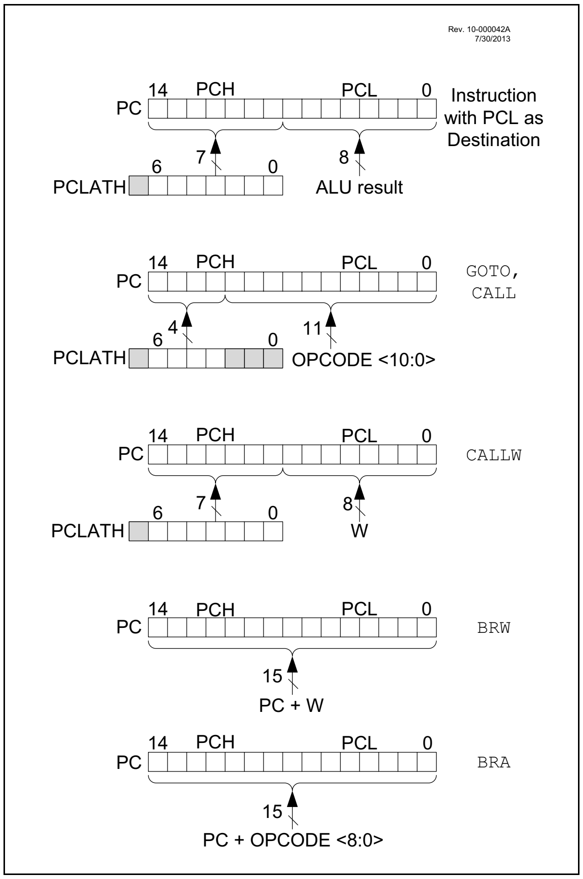
3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^{2}C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^{2}C specific or SMBus input buffer thresholds.

4.4 PCL and PCLATH

The Program Counter (PC) is 15 bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<14:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 4-4 shows the five situations for the loading of the PC.

FIGURE 4-4: LOADING OF PC IN DIFFERENT SITUATIONS



4.4.1 MODIFYING PCL

Executing any instruction with the PCL register as the destination simultaneously causes the Program Counter PC<14:8> bits (PCH) to be replaced by the contents of the PCLATH register. This allows the entire contents of the program counter to be changed by writing the desired upper seven bits to the PCLATH register. When the lower eight bits are written to the PCL register, all 15 bits of the program counter will change to the values contained in the PCLATH register and those being written to the PCL register.

4.4.2 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When performing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block). Refer to Application Note AN556, *"Implementing a Table Read"* (DS00556).

4.4.3 COMPUTED FUNCTION CALLS

A computed function CALL allows programs to maintain tables of functions and provide another way to execute state machines or look-up tables. When performing a table read using a computed function CALL, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block).

If using the CALL instruction, the PCH<2:0> and PCL registers are loaded with the operand of the CALL instruction. PCH<6:3> is loaded with PCLATH<6:3>.

The CALLW instruction enables computed calls by combining PCLATH and W to form the destination address. A computed CALLW is accomplished by loading the W register with the desired address and executing CALLW. The PCL register is loaded with the value of W and PCH is loaded with PCLATH.

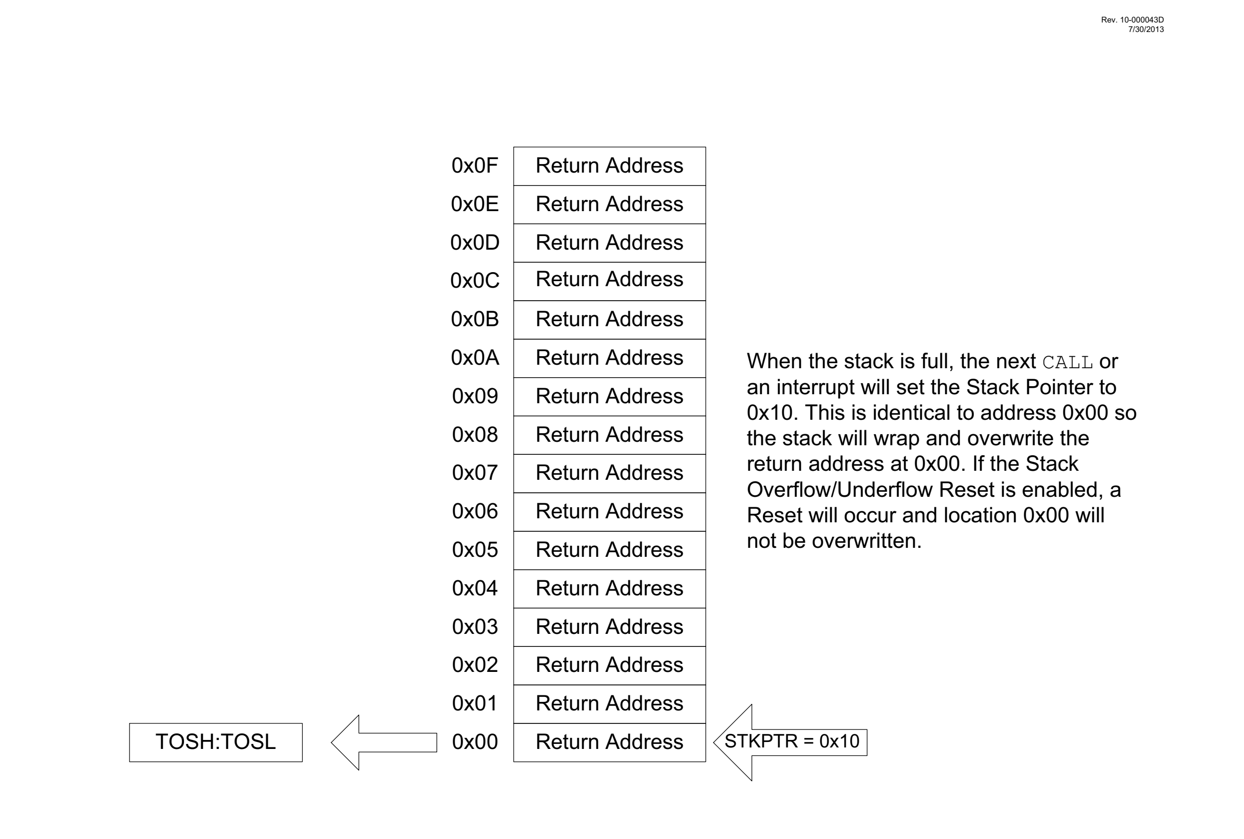
4.4.4 BRANCHING

The branching instructions add an offset to the PC. This allows relocatable code and code that crosses page boundaries. There are two forms of branching, BRW and BRA. The PC will have incremented to fetch the next instruction in both cases. When using either branching instruction, a PCL memory boundary may be crossed.

If using BRW, load the W register with the desired unsigned address and execute BRW. The entire PC will be loaded with the address PC + 1 + W.

If using BRA, the entire PC will be loaded with PC + 1 + the signed value of the operand of the BRA instruction.

FIGURE 4-8: ACCESSING THE STACK EXAMPLE 4



When the stack is full, the next `CALL` or an interrupt will set the Stack Pointer to 0x10. This is identical to address 0x00 so the stack will wrap and overwrite the return address at 0x00. If the Stack Overflow/Underflow Reset is enabled, a Reset will occur and location 0x00 will not be overwritten.

4.5.2 OVERFLOW/UNDERFLOW RESET

If the STVREN bit in Configuration Words (Register 5-2) is programmed to '1', the device will be Reset if the stack is PUSHed beyond the sixteenth level or POPed beyond the first level, setting the appropriate bits (STKOVF or STKUNF, respectively) in the PCON register.

4.6 Indirect Addressing

The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the File Select Registers (FSR). If the FSRn address specifies one of the two INDFn registers, the read will return '0' and the write will not occur (though Status bits may be affected). The FSRn register value is created by the pair FSRnH and FSRnL.

The FSR registers form a 16-bit address that allows an addressing space with 65536 locations. These locations are divided into three memory regions:

- Traditional/Banked Data Memory
- Linear Data Memory
- Program Flash Memory

8.2.3 BOR CONTROLLED BY SOFTWARE

When the BOREN bits of Configuration Words are programmed to ‘01’, the BOR is controlled by the SBOREN bit of the BORCON register. The device start-up is not delayed by the BOR ready condition or the VDD level.

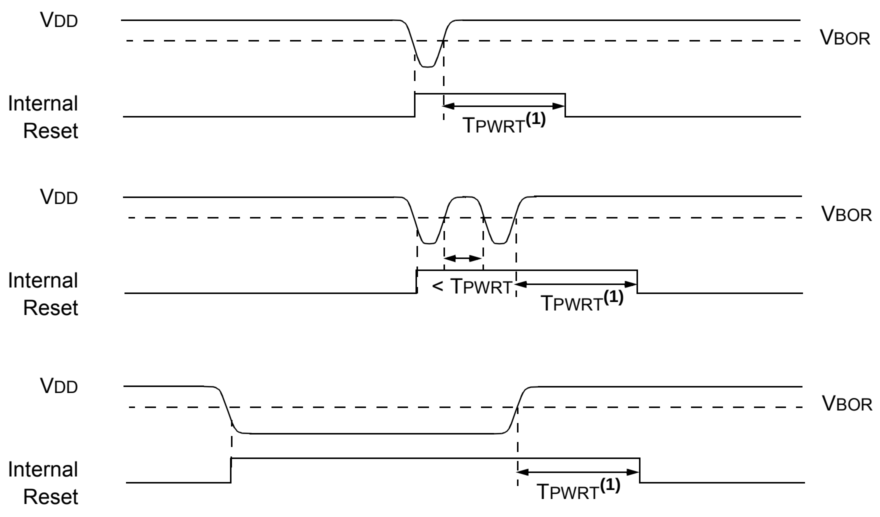
BOR protection begins as soon as the BOR circuit is ready. The status of the BOR circuit is reflected in the BORRDY bit of the BORCON register.

BOR protection is unchanged by Sleep.

8.2.4 BOR IS ALWAYS OFF

When the BOREN bits of the Configuration Words are programmed to ‘00’, the BOR is off at all times. The device start-up is not delayed by the BOR ready condition or the VDD level.

FIGURE 8-2: BROWN-OUT SITUATIONS



Note 1: TPWRT delay only if $\overline{\text{PWRTE}}$ bit is programmed to ‘0’.

8.12 Memory Execution Violation

A Memory Execution Violation Reset occurs if executing an instruction being fetched from outside the valid execution area. The different valid execution areas are defined as follows:

- Flash Memory: Table 4-1 shows the addresses available on the PIC16(L)F15356/75/76/85/86 devices based on user Flash size. Execution outside this region generates a memory execution violation.
- Storage Area Flash (SAF): If Storage Area Flash (SAF) is enabled (**Section 4.2.3 “Storage Area Flash”**), the SAF area (Table 4-2) is not a valid execution area.

Prefetched instructions that are not executed do not cause memory execution violations. For example, a `GOTO` instruction in the last memory location will prefetch from an invalid location; this is not an error. If an instruction from an invalid location tries to execute, the memory violation is generated immediately, and any concurrent interrupt requests are ignored. When a memory execution violation is generated, the device is reset and flag $\overline{\text{MEMV}}$ is cleared in PCON1 (Register 8-3) to signal the cause. The flag needs to be set in code after a memory execution violation.

9.2 Clock Source Types

Clock sources can be classified as external or internal.

External clock sources rely on external circuitry for the clock source to function. Examples are: oscillator modules (ECH, ECM, ECL mode), quartz crystal resonators or ceramic resonators (LP, XT and HS modes).

Internal clock sources are contained within the oscillator module. The internal oscillator block has two internal oscillators and a dedicated Phase Lock Loop (PLL) that are used to generate internal system clock sources. The High-Frequency Internal Oscillator (HFINTOSC) can produce a range from 1 to 32 MHz. The Low-Frequency Internal Oscillator (LFINTOSC) generates a 31 kHz frequency. The external oscillator block can also be used with the PLL. See **Section 9.2.1.4 “4x PLL”** for more details.

The system clock can be selected between external or internal clock sources via the NOSC bits in the OSCCON1 register. See **Section 9.3 “Clock Switching”** for additional information.

9.2.1 EXTERNAL CLOCK SOURCES

An external clock source can be used as the device system clock by performing one of the following actions:

- Program the RSTOSC<2:0> bits in the Configuration Words to select an external clock source that will be used as the default system clock upon a device Reset
- Write the NOSC<2:0> and NDIV<4:0> bits in the OSCCON1 register to switch the system clock source

See **Section 9.3 “Clock Switching”** for more information.

9.2.1.1 EC Mode

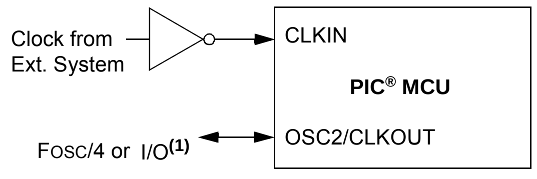
The External Clock (EC) mode allows an externally generated logic level signal to be the system clock source. When operating in this mode, an external clock source is connected to the OSC1 input. OSC2/CLKOUT is available for general purpose I/O or CLKOUT. Figure 9-2 shows the pin connections for EC mode.

EC mode has three power modes to select from through Configuration Words:

- ECH – High power, ≤ 32 MHz
- ECM – Medium power, ≤ 8 MHz
- ECL – Low power, ≤ 0.5 MHz

The Oscillator Start-up Timer (OST) is disabled when EC mode is selected. Therefore, there is no delay in operation after a Power-on Reset (POR) or wake-up from Sleep. Because the PIC® MCU design is fully static, stopping the external clock input will have the effect of halting the device while leaving all data intact. Upon restarting the external clock, the device will resume operation as if no time had elapsed.

FIGURE 9-2: EXTERNAL CLOCK (EC) MODE OPERATION



Note 1: Output depends upon $\overline{\text{CLKOUTEN}}$ bit of the Configuration Words.

9.2.1.2 LP, XT, HS Modes

The LP, XT and HS modes support the use of quartz crystal resonators or ceramic resonators connected to OSC1 and OSC2 (Figure 9-3). The three modes select a low, medium or high gain setting of the internal inverter-amplifier to support various resonator types and speed.

LP Oscillator mode selects the lowest gain setting of the internal inverter-amplifier. LP mode current consumption is the least of the three modes. This mode is designed to drive only 32.768 kHz tuning-fork type crystals (watch crystals).

XT Oscillator mode selects the intermediate gain setting of the internal inverter-amplifier. XT mode current consumption is the medium of the three modes. This mode is best suited to drive crystals and resonators with a medium drive level specification.

HS Oscillator mode selects the highest gain setting of the internal inverter-amplifier. HS mode current consumption is the highest of the three modes. This mode is best suited for resonators that require a high drive setting.

Figure 9-3 and Figure 9-4 show typical circuits for quartz crystal and ceramic resonators, respectively.

9.2.1.4 4x PLL

The oscillator module contains a PLL that can be used with external clock sources and internal oscillator to provide a system clock source. The input frequency for the PLL must fall within specifications. See the PLL Clock Timing Specifications in Table 37-9.

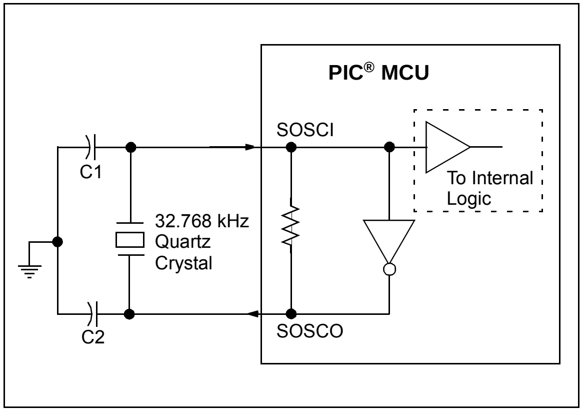
The PLL may be enabled for use by one of two methods:

1. Program the RSTOSC bits in the Configuration Word 1 to enable the EXTOSC with 4x PLL.
2. Write the NOSC bits in the OSCCON1 register to enable the EXTOSC with 4x PLL.

9.2.1.5 Secondary Oscillator

The secondary oscillator is a separate oscillator block that can be used as an alternate system clock source. The secondary oscillator is optimized for 32.768 kHz, and can be used with an external crystal oscillator connected to the SOSCI and SOSCO device pins, or an external clock source connected to the SOSCIN pin. Refer to **Section 9.3 "Clock Switching"** for more information.

FIGURE 9-5: QUARTZ CRYSTAL OPERATION (SECONDARY OSCILLATOR)



Note 1: Quartz crystal characteristics vary according to type, package and manufacturer. The user should consult the manufacturer data sheets for specifications and recommended application.

2: Always verify oscillator performance over the VDD and temperature range that is expected for the application.

3: For oscillator design assistance, reference the following Microchip Application Notes:

- AN826, "*Crystal Oscillator Basics and Crystal Selection for rfPIC® and PIC® Devices*" (DS00826)
- AN849, "*Basic PIC® Oscillator Design*" (DS00849)
- AN943, "*Practical PIC® Oscillator Analysis and Design*" (DS00943)
- AN949, "*Making Your Oscillator Work*" (DS00949)
- TB097, "*Interfacing a Micro Crystal MS1V-T1K 32.768 kHz Tuning Fork Crystal to a PIC16F690/SS*" (DS91097)
- AN1288, "*Design Practices for Low-Power External Oscillators*" (DS01288)

REGISTER 11-2: CPUDOZE: DOZE AND IDLE REGISTER

R/W-0/u	R/W/HC/HS-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
IDLEN	DOZEN[1,2]	ROI	DOE	—	DOZE<2:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **IDLEN:** Idle Enable bit
1 = A SLEEP instruction inhibits the CPU clock, but not the peripheral clock(s)
0 = A SLEEP instruction places the device into full Sleep mode

bit 6 **DOZEN:** Doze Enable bit[1,2]
1 = The CPU executes instruction cycles according to DOZE setting
0 = The CPU executes all instruction cycles (fastest, highest power operation)

bit 5 **ROI:** Recover-on-Interrupt bit
1 = Entering the Interrupt Service Routine (ISR) makes DOZEN = 0 bit, bringing the CPU to full-speed operation.
0 = Interrupt entry does not change DOZEN

bit 4 **DOE:** Doze on Exit bit
1 = Executing RETFIE makes DOZEN = 1, bringing the CPU to reduced speed operation.
0 = RETFIE does not change DOZEN

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **DOZE<2:0>:** Ratio of CPU Instruction Cycles to Peripheral Instruction Cycles
111 =1:256
110 =1:128
101 =1:64
100 =1:32
011 =1:16
010 =1:8
001 =1:4
000 =1:2

Note 1: When ROI = 1 or DOE = 1, DOZEN is changed by hardware interrupt entry and/or exit.
2: Entering ICD overrides DOZEN, returning the CPU to full execution speed; this bit is not affected.

13.3.3 NVMREG ERASE OF PFM

Before writing to PFM, the word(s) to be written must be erased or previously unwritten. PFM can only be erased one row at a time. No automatic erase occurs upon the initiation of the write to PFM.

To erase a PFM row:

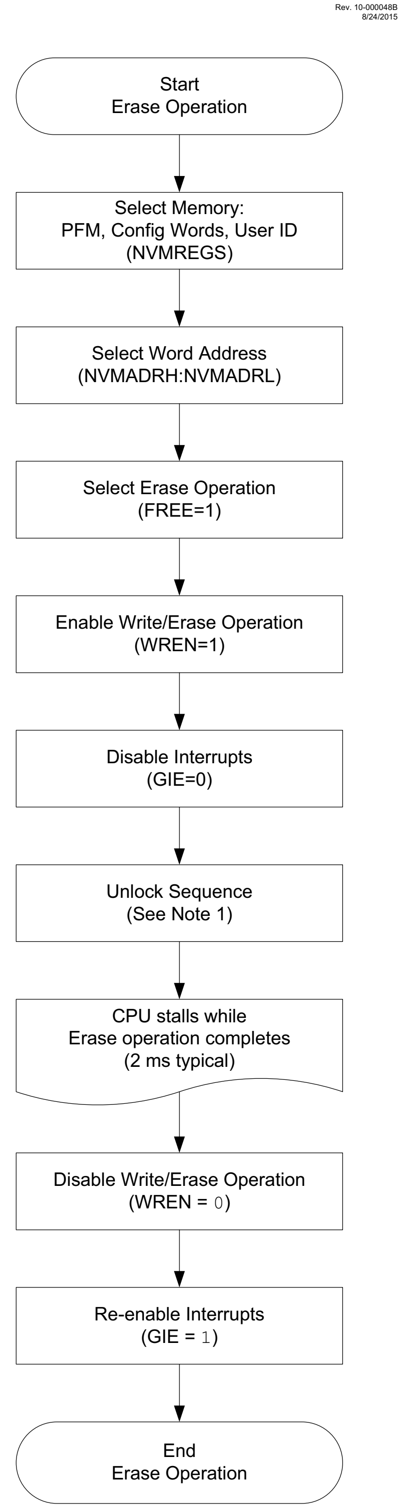
1. Clear the NVMREGS bit of the NVMCON1 register to erase PFM locations, or set the NMVREGS bit to erase User ID locations.
2. Write the desired address into the NVMADRH:NVMADRL register pair (Table 13-2).
3. Set the FREE and WREN bits of the NVMCON1 register.
4. Perform the unlock sequence as described in **Section 13.3.2 "NVM Unlock Sequence"**.

If the PFM address is write-protected, the WR bit will be cleared and the erase operation will not take place.

While erasing PFM, CPU operation is suspended, and resumes when the operation is complete. Upon completion, the NVMIF is set, and an interrupt will occur if the NVMIE bit is also set.

Write latch data is not affected by erase operations, and WREN will remain unchanged.

FIGURE 13-3: NVM ERASE FLOWCHART



Note 1: See Figure 13-2.

14.10.8 PORTE FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 15.0 “Peripheral Pin Select (PPS) Module”** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

REGISTER 14-35: LATE: PORTE DATA LATCH REGISTER[1]

U-0	U-0	U-0	U-0	U-0	R/W-1/1	R/W-1/1	R/W-1/1
—	—	—	—	—	LATE2	LATE1	LATE0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-3 **Unimplemented:** Read as ‘0’

bit 2-0 **LATE<2:0>**: PORTE Output Latch Value bits

Note 1: Present on PIC16(L)F15375/76/85/86 only.

2: Writes to PORTE are actually written to corresponding LATE register. Reads from PORTE register is return of actual I/O pin values.

REGISTER 14-36: ANSELE: PORTE ANALOG SELECT REGISTER[1]

U-0	U-0	U-0	U-0	U-0	R/W-1/1	R/W-1/1	R/W-1/1
—	—	—	—	—	ANSE2	ANSE1	ANSE0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-3 **Unimplemented:** Read as ‘0’

bit 2-0 **ANSE<2:0>**: Analog Select between Analog or Digital Function on Pins RE<2:0>, respectively[2]
0 = Digital I/O. Pin is assigned to port or digital special function.
1 = Analog input. Pin is assigned as analog input[2]. Digital input buffer disabled.

Note 1: Present on PIC16(L)F15375/76/85/86 only.

2: When setting a pin to an analog input, the corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

REGISTER 14-46: ODCONF: PORTF OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCF7	ODCF6	ODCF5	ODCF4	ODCF3	ODCF2	ODCF1	ODCF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ODCF<7:0>:** PORTF Open-Drain Enable bits
For RF<7:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

REGISTER 14-47: SLRCONF: PORTF SLEW RATE CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SLRF7	SLRF6	SLRF5	SLRF4	SLRF3	SLRF2	SLRF1	SLRF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **SLRF<7:0>:** PORTF Slew Rate Enable bits
For RF<7:0> pins, respectively
1 = Port pin slew rate is limited
0 = Port pin slews at maximum rate

REGISTER 14-48: INLVLF: PORTF INPUT LEVEL CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
INLVLF7	INLVLF6	INLVLF5	INLVLF4	INLVLF3	INLVLF2	INLVLF1	INLVLF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **INLVLF<7:0>:** PORTF Input Level Select bits
For RF<7:0> pins, respectively
1 = ST input used for PORT reads and interrupt-on-change
0 = TTL input used for PORT reads and interrupt-on-change

23.3 Comparator Hysteresis

A selectable amount of separation voltage can be added to the input pins of each comparator to provide a hysteresis function to the overall operation. Hysteresis is enabled by setting the CxHYS bit of the CMxCON0 register.

See Comparator Specifications in Table 37-14 for more information.

23.4 Timer1 Gate Operation

The output resulting from a comparator operation can be used as a source for gate control of Timer1. See **Section 26.6 “Timer Gate”** for more information. This feature is useful for timing the duration or interval of an analog event.

It is recommended that the comparator output be synchronized to Timer1. This ensures that Timer1 does not increment while a change in the comparator is occurring.

23.4.1 COMPARATOR OUTPUT SYNCHRONIZATION

The output from a comparator can be synchronized with Timer1 by setting the CxSYNC bit of the CMxCON0 register.

Once enabled, the comparator output is latched on the falling edge of the Timer1 source clock. If a prescaler is used with Timer1, the comparator output is latched after the prescaling function. To prevent a race condition, the comparator output is latched on the falling edge of the Timer1 clock source and Timer1 increments on the rising edge of its clock source. See the Comparator Block Diagram (Figure 23-2) and the Timer1 Block Diagram (Figure 26-1) for more information.

23.5 Comparator Interrupt

An interrupt can be generated upon a change in the output value of the comparator for each comparator, a rising edge detector and a falling edge detector are present.

When either edge detector is triggered and its associated enable bit is set (CxINTP and/or CxINTN bits of the CMxCON1 register), the Corresponding Interrupt Flag bit (CxIF bit of the PIR2 register) will be set.

To enable the interrupt, you must set the following bits:

- CxON, CxPOL and CxSP bits of the CMxCON0 register
- CxIE bit of the PIE2 register
- CxINTP bit of the CMxCON1 register (for a rising edge detection)
- CxINTN bit of the CMxCON1 register (for a falling edge detection)
- PEIE and GIE bits of the INTCON register

The associated interrupt flag bit, CxIF bit of the PIR2 register, must be cleared in software. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

Note:	Although a comparator is disabled, an interrupt can be generated by changing the output polarity with the CxPOL bit of the CMxCON0 register, or by switching the comparator on or off with the CxON bit of the CMxCON0 register.

23.6 Comparator Positive Input Selection

Configuring the CxPCH<2:0> bits of the CMxPSEL register directs an internal voltage reference or an analog pin to the noninverting input of the comparator:

- CxIN0+ analog pin
- DAC output
- FVR (Fixed Voltage Reference)
- VSS (Ground)

See **Section 18.0 “Fixed Voltage Reference (FVR)”** for more information on the Fixed Voltage Reference module.

See **Section 21.0 “5-Bit Digital-to-Analog Converter (DAC1) Module”** for more information on the DAC input signal.

Any time the comparator is disabled (CxON = 0), all comparator inputs are disabled.

23.7 Comparator Negative Input Selection

The CxNCH<2:0> bits of the CMxCON1 register direct an analog input pin and internal reference voltage or analog ground to the inverting input of the comparator:

- CxIN- pin
- FVR (Fixed Voltage Reference)
- Analog Ground

Note:	To use CxINy+ and CxINy- pins as analog input, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

REGISTER 27-4: T2RST: TIMER2 EXTERNAL RESET SIGNAL SELECTION REGISTER

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	RSEL<3:0>			
bit 7							bit 0

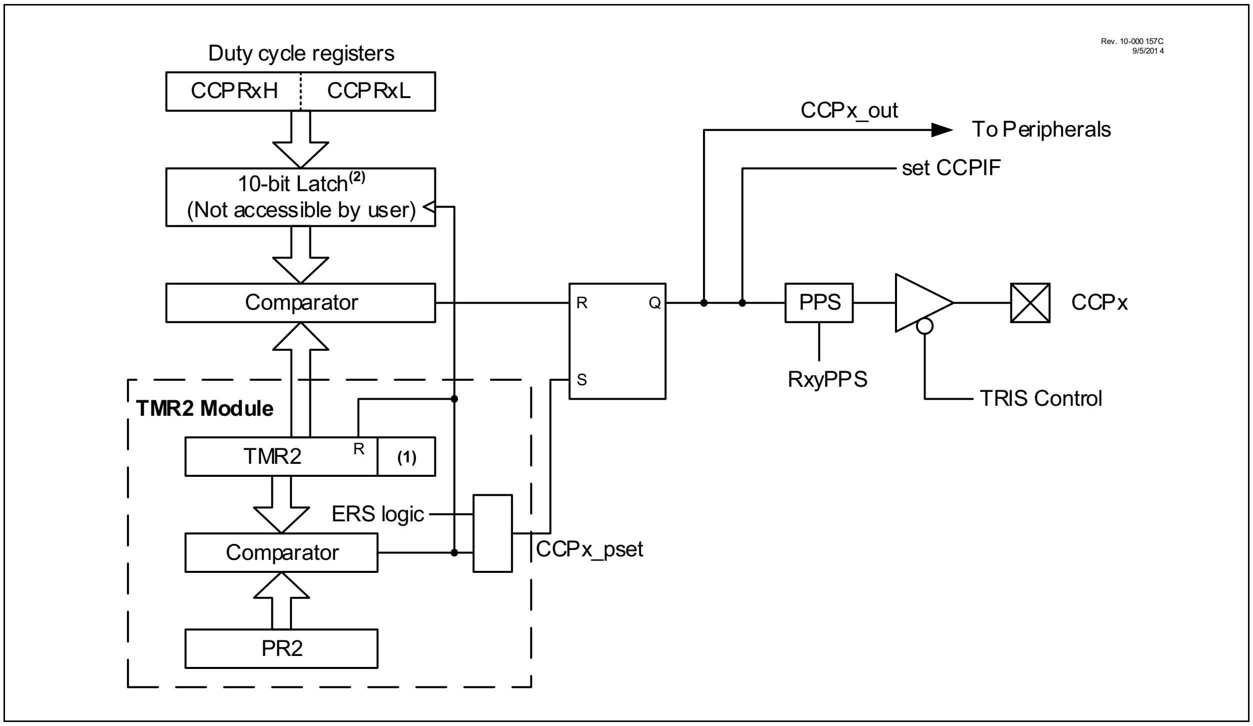
Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **RSEL<3:0>:** Timer2 External Reset Signal Source Selection bits

1111 = Reserved
1101 = LC4_out
1100 = LC3_out
1011 = LC2_out
1010 = LC1_out
1001 = ZCD1_output
1000 = C2OUT_sync
0111 = C1OUT_sync
0110 = PWM6_out
0101 = PWM5_out
0100 = PWM4_out
0011 = PWM3_out
0010 = CCP2_out
0001 = CCP1_out
0000 = T2INPPS

FIGURE 28-4: SIMPLIFIED PWM BLOCK DIAGRAM



28.3.2 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for standard PWM operation:

1. Use the desired output pin RxyPPS control to select CCPx as the source and disable the CCPx pin output driver by setting the associated TRIS bit.
2. Load the PR2 register with the PWM period value.
3. Configure the CCP module for the PWM mode by loading the CCPxCON register with the appropriate values.
4. Load the CCPRxL register, and the CCPRxH register with the PWM duty cycle value and configure the CCPxFMT bit of the CCPxCON register to set the proper register alignment.
5. Configure and start Timer2:
   - Clear the TMR2IF interrupt flag bit of the PIR4 register. See Note below.
   - Configure the CKPS bits of the T2CON register with the Timer prescale value.
   - Enable the Timer by setting the Timer2 ON bit of the T2CON register.
6. Enable PWM output pin:
   - Wait until the Timer overflows and the TMR2IF bit of the PIR4 register is set. See Note below.
   - Enable the CCPx pin output driver by clearing the associated TRIS bit.

Note:	In order to send a complete duty cycle and period on the first PWM output, the above steps must be included in the setup sequence. If it is not critical to start with a complete PWM signal on the first output, then step 6 may be ignored.

28.3.3 CCP/PWM CLOCK SELECTION

The PIC16(L)F15356/75/76/85/86 allows each individual CCP and PWM module to select the timer source that controls the module. Each module has an independent selection.

32.2.6 SPI OPERATION IN SLEEP MODE

In SPI Master mode, module clocks may be operating at a different speed than when in Full-Power mode; in the case of the Sleep mode, all clocks are halted.

In SPI Master mode, when the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the device wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in Sleep mode and data to be shifted into the SPI Transmit/Receive Shift register. When all eight bits have been received, the MSSP interrupt flag bit will be set and if enabled, will wake the device.

32.3 I^{2}C MODE OVERVIEW

The Inter-Integrated Circuit (I^{2}C) bus is a multi-master serial data communication bus. Devices communicate in a master/slave environment where the master devices initiate the communication. A slave device is controlled through addressing.

The I^{2}C bus specifies two signal connections:

- Serial Clock (SCL)
- Serial Data (SDA)

Figure 32-11 shows the block diagram of the MSSP module when operating in I^{2}C mode.

Both the SCL and SDA connections are bidirectional open-drain lines, each requiring pull-up resistors for the supply voltage. Pulling the line to ground is considered a logical zero and letting the line float is considered a logical one.

Figure 32-11 shows a typical connection between two processors configured as master and slave devices.

The I^{2}C bus can operate with one or more master devices and one or more slave devices.

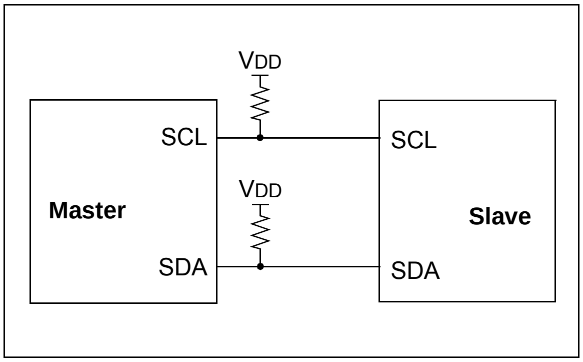
There are four potential modes of operation for a given device:

- Master Transmit mode
  (master is transmitting data to a slave)
- Master Receive mode
  (master is receiving data from a slave)
- Slave Transmit mode
  (slave is transmitting data to a master)
- Slave Receive mode
  (slave is receiving data from the master)

To begin communication, a master device starts out in Master Transmit mode. The master device sends out a Start bit followed by the address byte of the slave it intends to communicate with. This is followed by a single Read/Write bit, which determines whether the master intends to transmit to or receive data from the slave device.

If the requested slave exists on the bus, it will respond with an Acknowledge bit, otherwise known as an $\overline{\text{ACK}}$. The master then continues in either Transmit mode or Receive mode and the slave continues in the complement, either in Receive mode or Transmit mode, respectively.

FIGURE 32-11: I^{2}C MASTER/ SLAVE CONNECTION



The Acknowledge bit ($\overline{\text{ACK}}$) is an active-low signal, which holds the SDA line low to indicate to the transmitter that the slave device has received the transmitted data and is ready to receive more.

The transition of a data bit is always performed while the SCL line is held low. Transitions that occur while the SCL line is held high are used to indicate Start and Stop bits.

On the last byte of data communicated, the master device may end the transmission by sending a Stop bit. If the master device is in Receive mode, it sends the Stop bit in place of the last $\overline{\text{ACK}}$ bit. A Stop bit is indicated by a low-to-high transition of the SDA line while the SCL line is held high.

In some cases, the master may want to maintain control of the bus and re-initiate another transmission. If so, the master device may send another Start bit in place of the Stop bit.

REGISTER 32-3: SSPxCON2: SSPx CONTROL REGISTER 2 (I^{2}C MODE ONLY)[1]

R/W-0/0	R/HS/HC-0	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0	R/S/HC-0/0	R/S/HC-0/0	R/S/HC-0/0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HC = Cleared by hardware S = User set

bit 7 **GCEN:** General Call Enable bit (in I^{2}C Slave mode only)
`1` = Enable interrupt when a general call address (0x00 or 00h) is received in the SSPxSR
`0` = General call address disabled

bit 6 **ACKSTAT:** Acknowledge Status bit (in I^{2}C mode only)
`1` = Acknowledge was not received
`0` = Acknowledge was received

bit 5 **ACKDT:** Acknowledge Data bit (in I^{2}C mode only)
In Receive mode:
Value transmitted when the user initiates an Acknowledge sequence at the end of a receive
`1` = Not Acknowledge
`0` = Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit (in I^{2}C Master mode only)
In Master Receive mode:
`1` = Initiate Acknowledge sequence on SDA and SCL pins, and transmit ACKDT data bit. Automatically cleared by hardware.
`0` = Acknowledge sequence idle

bit 3 **RCEN:** Receive Enable bit (in I^{2}C Master mode only)
`1` = Enables Receive mode for I^{2}C
`0` = Receive idle

bit 2 **PEN:** Stop Condition Enable bit (in I^{2}C Master mode only)
SCKMSSP Release Control:
`1` = Initiate Stop condition on SDA and SCL pins. Automatically cleared by hardware.
`0` = Stop condition Idle

bit 1 **RSEN:** Repeated Start Condition Enable bit (in I^{2}C Master mode only)
`1` = Initiate Repeated Start condition on SDA and SCL pins. Automatically cleared by hardware.
`0` = Repeated Start condition Idle

bit 0 **SEN:** Start Condition Enable/Stretch Enable bit
In Master mode:
`1` = Initiate Start condition on SDA and SCL pins. Automatically cleared by hardware.
`0` = Start condition Idle
In Slave mode:
`1` = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)
`0` = Clock stretching is disabled

Note 1: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I^{2}C module is not in the IDLE mode, this bit may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

MOVIW Move INDFn to W

Syntax:	[*label*] MOVIW ++FSRn [*label*] MOVIW --FSRn [*label*] MOVIW FSRn++ [*label*] MOVIW FSRn-- [*label*] MOVIW k[FSRn]
Operands:	n ∈ [0,1] mm ∈ [00,01, 10, 11] -32 ≤ k ≤ 31
Operation:	INDFn → W Effective address is determined by • FSR + 1 (preincrement) • FSR - 1 (predecrement) • FSR + k (relative offset) After the Move, the FSR value will be either: • FSR + 1 (all increments) • FSR - 1 (all decrements) • Unchanged
Status Affected:	Z

Mode	Syntax	mm
Preincrement	++FSRn	00
Predecrement	--FSRn	01
Postincrement	FSRn++	10
Postdecrement	FSRn--	11

Description:	This instruction is used to move data between W and one of the indirect registers (INDFn). Before/after this move, the pointer (FSRn) is updated by pre/post incrementing/decrementing it. **Note:** The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the FSRn. FSRn is limited to the range 0000h - FFFFh. Incrementing/decrementing it beyond these bounds will cause it to wrap-around.

MOVLB Move literal to BSR

Syntax:	[*label*] MOVLB k
Operands:	0 ≤ k ≤
Operation:	k → BSR
Status Affected:	None
Description:	The 6-bit literal ‘k’ is loaded into the Bank Select Register (BSR).

MOVLP Move literal to PCLATH

Syntax:	[*label*] MOVLP k
Operands:	0 ≤ k ≤ 127
Operation:	k → PCLATH
Status Affected:	None
Description:	The 7-bit literal ‘k’ is loaded into the PCLATH register.

MOVLW Move literal to W

Syntax:	[*label*] MOVLW k
Operands:	0 ≤ k ≤ 255
Operation:	k → (W)
Status Affected:	None
Description:	The 8-bit literal ‘k’ is loaded into W register. The “don’t cares” will assemble as ‘0’s.
Words:	1
Cycles:	1

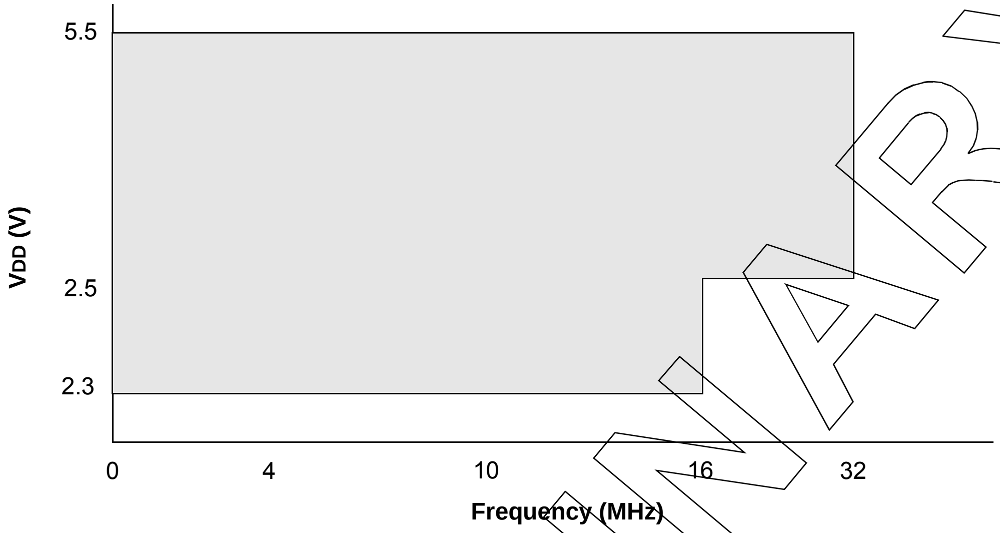
<u>Example:</u>	`MOVLW 0x5A`
	After Instruction
	W = 0x5A

MOVWF Move W to f

Syntax:	[*label*] MOVWF f
Operands:	0 ≤ f ≤ 127
Operation:	(W) → (f)
Status Affected:	None
Description:	Move data from W register to register ‘f’.
Words:	1
Cycles:	1

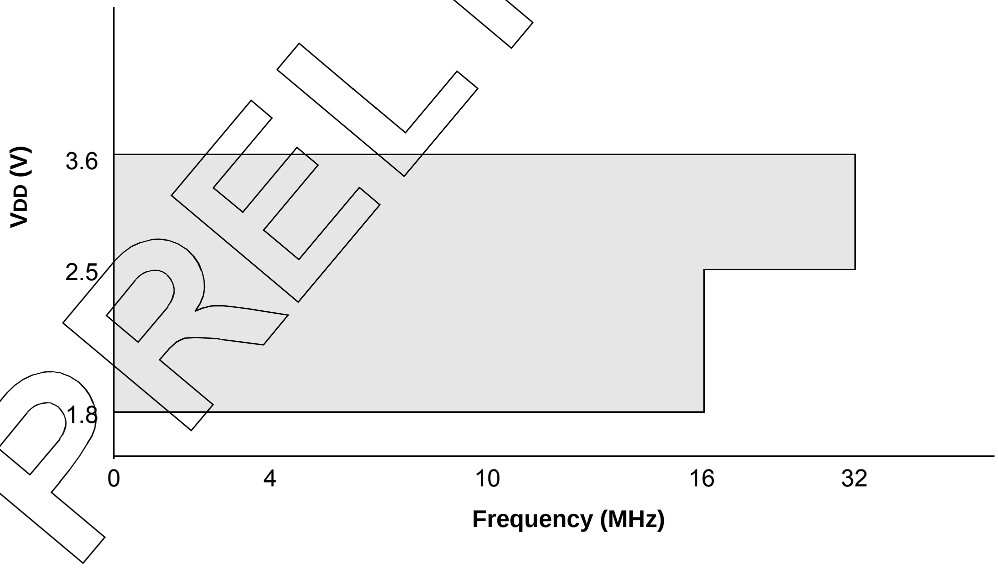
<u>Example:</u>	`MOVWF LATA`
	Before Instruction
	LATA = 0xFF
	W = 0x4F
	After Instruction
	LATA = 0x4F
	W = 0x4F

FIGURE 37-1: VOLTAGE FREQUENCY GRAPH, -40°C ≤ TA ≤ +125°C, PIC16F15356/75/76/85/86 ONLY



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.
2: Refer to Table 37-7 for each Oscillator mode's supported frequencies.

FIGURE 37-2: VOLTAGE FREQUENCY GRAPH, -40°C ≤ TA ≤ +125°C, PIC16LF15356/75/76/85/86 ONLY



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.
2: Refer to Table 37-7 for each Oscillator mode's supported frequencies.